In the Claims

1	[0072] 1.(currently amended) An MRI coil apparatus comprising:	
2	four members, each member including a superconducting layer, where the members are	
3	arranged to form a closed shape having four overlapping regions, and	
4	separating dielectric layers interposed between the superconducting layers at the overlapping	
5	regions to form built-in capacitors.	
1	[0073] 2.(original) The apparatus of claim 1, wherein each member comprises a substrate	
2	dielectric layer upon which the superconducting layer was formed.	
1	[0074] 3.(original) The apparatus of claim 2, wherein the substrate dielectric layers are rigid.	
1	[0075] 4.(original) The apparatus of claim 2, wherein two of the substrate dielectric layers are	
2	rigid and two of the substrate dielectric layers are flexible.	
1	[0076] 5.(currently amended) The apparatus of any of the preceding claims claim 1, wherein	
2	the members are straight.	
1	[0077] 6.(currently amended) The apparatus of claims 1, 2, 3, or 4, wherein two of the	
2	members are straight and two of the members are curvilinear.	
1	[0078] 7.(currently amended) The apparatus of claims 1, 2, 3, or 4, wherein two of the	
2	members are straight and two of the members are arcuate.	
1	[0079] 8.(currently amended) The apparatus of any of the preceding claims claim 1, wherein	
2	the substrate dielectric layers are the separating dielectric layers.	
1	[0080] 9.(currently amended) The apparatus of any of the preceding claims claim 1, further	
2	comprising:	
3	a metal layer formed on an exposed portion of a dielectric layer or an external dielectric layer	
4	formed form on an exposed portion of a superconducting layer with a metal layer formed on the outer	

5 surface of the external dielectric layer to form coupling or decoupling capacitive elements. [0081] 10.(original) The apparatus of claim 9, further comprising: 1 wires bonded to the metal layers, where the metal wires are adapted to link a plurality of the 2 3 apparatus together to form arrays or to connect the apparatus to a pre-amplifier. [0082] 11.(original) A hybrid MRI coil apparatus comprising: 2 two superconducting members, each member including a superconducting layer, 3 two metal member, and 4 separating dielectric layers, 5 where the superconducting members and the metal member are arranged to form a closed shape 6 having four overlapping regions and the separating dielectric layers are interposed between the 7 superconducting layers and the metal members at the overlapping regions to form built-in capacitors. [0083] 12.(original) The apparatus of claim 11, wherein each superconducting member comprises 2 a substrate dielectric layer upon which the superconducting layer was formed. [0084] 13.(original) The apparatus of claim 12, wherein the substrate dielectric layers are rigid. 1 [0085] 14.(original) The apparatus of claim 12, wherein two of the substrate dielectric layers are 2 rigid and two of the substrate dielectric layers are flexible. 1 [0086] 15.(currently amended) The apparatus of claims 11, 12, 13, or 14 wherein the 2 superconducting members are straight. [0087] 16.(currently amended) 1 The apparatus of claims 11, 12, 13, or 14, wherein the 2 superconducting members are curvilinear. [0088] 17.(currently amended) 1 The apparatus of claims 11, 12, 13, or 14, wherein

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superconducting members are arcuate.

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1	[0089] 18.(currently amended) The apparatus of claims 11, 12, 13, 14, 15, 16 or 17, where
2	the substrate dielectric layers are the separating dielectric layers.
1	[0090] 19.(currently amended) The apparatus of 11, 12, 13, 14, 15, 16 17 or 18, furth
2	comprising:
3	a metal layer formed on an exposed portion of a dielectric layer or a external dielectric lay
4	formed form on an exposed portion of a superconducting layer with a metal layer formed on the out
5	surface of the external dielectric layer to form coupling or decoupling capacitive elements.
1	[0091] 20.(original) The apparatus of claim 19, further comprising:
2	wires bonded to the metal layers, where the metal wires are adapted to link a plurality of the
3	apparatus together to form arrays or to connect the apparatus to a pre-amplifier.
1	[0092] 21.(original) A birdcage-type resonator apparatus comprising:
2	a plurality of coils apparatus including:
3	four members, each member including a superconducting layer, where the membe
4	arranged to form a closed shape having four overlapping regions, and
5	separating dielectric layers interposed between the superconducting layers at the
6	overlapping regions to form built-in capacitors, and
7	at least one small animal cavity,
8	where the coil apparatus are arranged around the cavity to permit MRI imaging of an animal place
9	within the cavity.
1	[0093] 22.(original) The apparatus of claim 21, wherein each member comprises a substra
2	dielectric layer upon which the superconducting layer was formed.
1	[0094] 23.(original) The apparatus of claim 22, wherein the substrate dielectric layers are rigid
1	[0095] 24.(original) The apparatus of claim 22, wherein two of the substrate dielectric layers as
2	rigid and two of the substrate dielectric layers are flexible.

1	[0096] 25.(currently amended)	The apparatus of 21, 22, 23 or 24, wherein the members are		
2	straight.			
1	[0097] 26.(currently amended)	The apparatus of claims 21, 22, 23, or 24, wherein two of the		
2	members are straight and two of the m	embers are curvilinear.		
1	[0098] 27.(currently amended)	The apparatus of claims 21, 22, 23, or 24, wherein two of the		
2	members are straight and two of the m	nembers are arcuate.		
1	[0099] 28.(currently amended)	The apparatus of claims 21, 22, 23, 24, 25, 26 or 27, wherein		
2	the substrate dielectric layers are the separating dielectric layers.			
1	[0100] 29.(currently amended)	The apparatus of claims 21, 22, 23, 24, 25, 26, 27 or 28, further		
2	comprising:			
3	a metal layer formed on an expo	a metal layer formed on an exposed portion of a dielectric layer or a external dielectric layer		
4	formed form on an exposed portion of a superconducting layer with a metal layer formed on the outer			
5	surface of the external dielectric layer	to form coupling or decoupling capacitive elements.		
1	[0101] 30.(original) The apparatus o	f claim 29, further comprising:		
2	wires bonded to the metal layer	s, where the metal wires are adapted to link a plurality of the		
3	apparatus together to form arrays or to	connect the apparatus to a pre-amplifier.		
1	[0102] 21 (aniain al) A 1: 1			
1	[0102] 31.(original) A birdcage-type resonator apparatus comprising:			
2	a plurality of coils apparatus in			
3	two superconducting members, each member including a superconducting layer,			
4	two metal member, and			
5	separating dielectric layers, and			
6	at least one small animal cavity			
7		round the cavity to permit MRI imaging of an animal placed		
8		conducting members and the metal member are arranged to		
9	form a closed shape having four overlapping regions and the separating dielectric layers are			

- interposed between the superconducting layers and the metal members at the overlapping regions to 10 form built-in capacitors. 11 [0103] 32.(original) The apparatus of claim 31, wherein each superconducting member comprises 1 2 a substrate dielectric layer upon which the superconducting layer was formed. [0104] 33.(original) The apparatus of claim 32, wherein the substrate dielectric layers are rigid. 1 [0105] 34.(original) The apparatus of claim32, wherein two of the substrate dielectric layers are 1 2 rigid and two of the substrate dielectric layers are flexible. The apparatus of claims 31, 32, 33, or 34 wherein the [0106] 35.(currently amended) 1 2 superconducting members are straight. [0107] 36.(currently amended) The apparatus of claims 31, 32, 33, or 34, wherein the 1 2 superconducting members are curvilinear. The apparatus of claims 31, 32, 33, or 34, wherein 2 superconducting members are arcuate. The apparatus of claims 31, 32, 33, 34, 35, 36 or 37, wherein [0109] 38.(currently amended) 1 2 the substrate dielectric layers are the separating dielectric layers. [0110] 39.(currently amended) The apparatus of 31, 32, 33, 34, 35, 36 37 or 38, further 2 comprising: 3 a metal layer formed on an exposed portion of a dielectric layer or a external dielectric layer formed form on an exposed portion of a superconducting layer with a metal layer formed on the outer 4
 - [0111] 40.(original) The apparatus of claim 39, further comprising:
 - wires bonded to the metal layers, where the metal wires are adapted to link a plurality of the

surface of the external dielectric layer to form coupling or decoupling capacitive elements.

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1	[0112] 41.(currently amended) A small animal MRI apparatus comprising:		
2	a vacuum housing including at least one cylindrical cavity adapted to receive a small animal,		
3	a coolant reservoir including a coolant, a coolant inlet, a coolant outlet and a cold plate		
4	forming an internal end of the reservoir,		
5	a resonator of claims 21-40 surrounding each cavity or a plurality of coils of claims 1-20		
6	positioned within the housing to permit MRI imaging of an animal in each of the cavities, where the		
7	resonator comprises:		
8	a plurality of coils apparatus including:		
9	four members, each member including a superconducting layer, where the members		
0	arranged to form a closed shape having four overlapping regions, and		
1	separating dielectric layers interposed between the superconducting layers at the		
2	overlapping regions to form built-in capacitors, and		
3	at least one small animal cavity,		
4	where the coil apparatus are arranged around the cavity to permit MRI imaging of an animal placed		
5	within the cavity.		
1	[0113] 42.(new) A small animal MRI apparatus comprising:		
2	a vacuum housing including at least one cylindrical cavity adapted to receive a small animal,		
3	a coolant reservoir including a coolant, a coolant inlet, a coolant outlet and a cold plate		
4	forming an internal end of the reservoir,		
5	a plurality of coils positioned within the housing to permit MRI imaging of an animal in each		
6	of the cavities, where the each coil comprises:		
7	four members, each member including a superconducting layer, where the members are		
8	arranged to form a closed shape having four overlapping regions, and		
9	separating dielectric layers interposed between the superconducting layers at the overlapping		
)	regions to form built-in capacitors.		

apparatus together to form arrays or to connect the apparatus to a pre-amplifier.

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